

Is Now Part of



# **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



### FDD7N25LZ N-Channel UniFET<sup>™</sup> MOSFET **250 V, 6.2 A, 550 m**Ω

#### **Features**

- R<sub>DS(on)</sub> = 430 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3.1 A
- Low Gate Charge (Typ. 12 nC)
- Low C<sub>rss</sub> (Typ. 8 pF)
- · 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Improved Capability
- RoHS Compliant

#### Applications

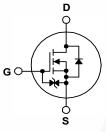
- LCD/LED/PDP TV
- · Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

FDD7N25LZ — N-Channel UniFET<sup>TM</sup> MOSFET

## Description

UniFET<sup>TM</sup> MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

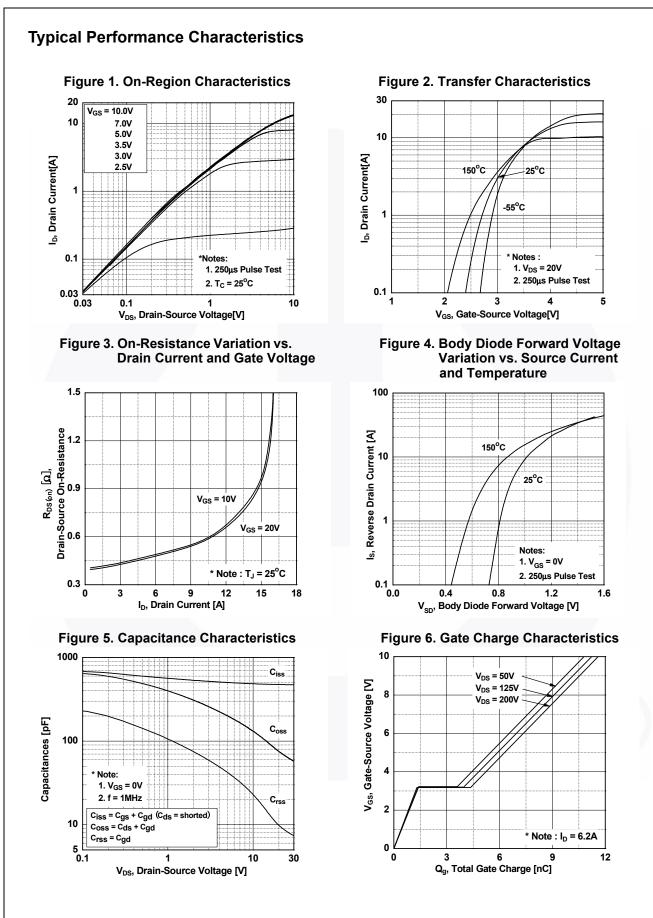
Symbol	Parameter			FDD7N25LZTM	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			250	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		6.2	^	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		3.7	- A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	25	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			115	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	5.5	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	5.6	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	ote 3) 10			
P <sub>D</sub>	Deven Dississeties	(T <sub>C</sub> = 25 <sup>o</sup> C)		56	W	
	Power Dissipation	- Derate Above 25°C		0.45	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			°C	

#### **Thermal Characteristics**

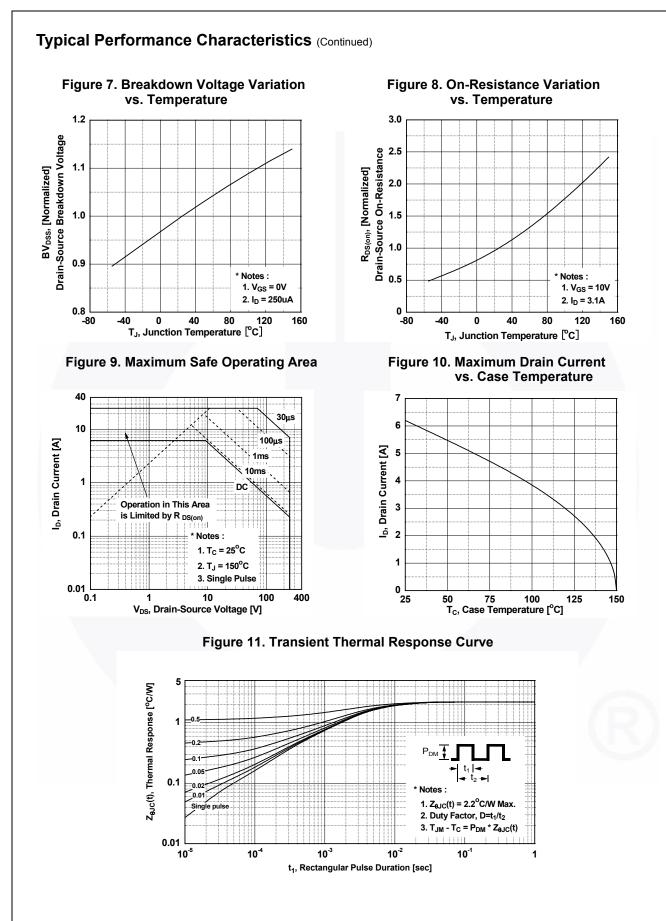
FDD7N25LZ Rev. 1.5

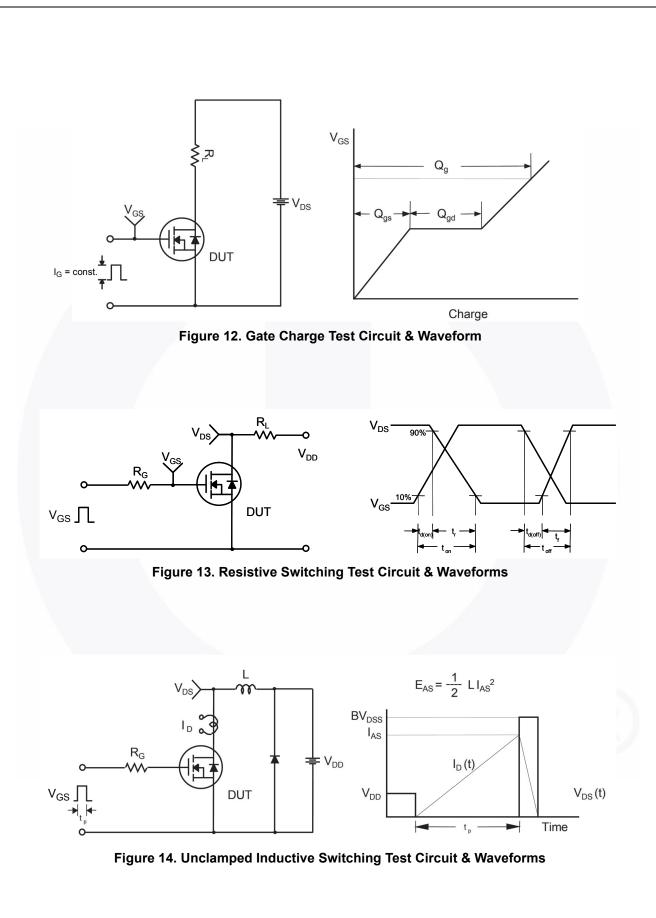
Symbol	Parameter	FDD7N25LZTM		
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	110	0/11	

Part Number		Top Mark	Packag	e Packing Method	Reel Size	e Ta	ape Width	Qu	antity
FDD7N25			DPAK	Tape and Reel	330 mm		16 mm	2500 units	
Electrica	l Chara	icteristics T <sub>C</sub> = 25°	C unless ot	herwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV <sub>DSS</sub>				= -250 + 4 + 1/2 = -0.1/1	$= 25^{\circ}$ C	250	-		V
∆BV <sub>DSS</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature			$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V, \ T_C = 25^{\circ}\text{C}$		200	-	-	-
$/\Delta T_J$ Coefficier				$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.25	-	V/°C
	Zoro Cot			V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		-	-	1	μA
DSS	Zero Gate Voltage Drain Current		١	$V_{DS} = 200 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	10	
GSSF	Gate to Body Leakage Current, Forward		orward \	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V		-	-	10	μA
I <sub>GSSR</sub>	Gate to Body Leakage Current, Reverse		everse \	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V		-	-	-10	μA
On Charac	torictics								
			, ,	( )( ) 050 A		4.0		0.5	
V <sub>GS(th)</sub>	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_D = 250 \mu A$		1.0	-	2.5	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance		nce L	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.1 \text{ A}$		-	0.43	0.55	Ω
	Forward	Transconductance		$V_{GS} = 5 V, I_D = 3.1 A$ $V_{DS} = 20 V, I_D = 3.1 A$		-	0.45 7	0.57	S
9 <sub>FS</sub>	TUIWalu	Transconductance		$v_{\rm DS} = 20  v,  v_{\rm D} = 3.1  {\rm A}$		-	1	-	3
Dynamic C	haracte	ristics							
C <sub>iss</sub>	Input Cap	pacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$		-	480	635	pF
C <sub>oss</sub>	Output C	apacitance				-	65	85	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance		f = 1 MHz	_	-	8	12	pF
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V	1	V <sub>DS</sub> = 250 V I <sub>D</sub> = 6.2 A,		-	12	16	nC
Q <sub>gs</sub>	Gate to S	Source Gate Charge		$V_{GS} = 10 V$		-	1.5	-	nC
Q <sub>gd</sub>	Gate to D	Drain "Miller" Charge			(Note 4)	-	4	-	nC
Switching	Characte	eristics							
t <sub>d(on)</sub>		Delay Time				-	10	30	ns
t <sub>r</sub>		Rise Time	\ \	V <sub>DD</sub> = 250 V, I <sub>D</sub> = 6.2 A,		-	15	40	ns
t <sub>d(off)</sub>		Delay Time		$V_{\rm GS}$ = 10 V, R <sub>G</sub> = 25 $\Omega$	-		75	160	ns
t <sub>f</sub>	Turn-Off I	,			(Note 4)		30	70	ns
·		Characteristics	I			7	11		
	1	e Characteristics	Iroo Diodo I	Enward Current		-		6.2	A
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward Current				-	-	25	A	
I <sub>SM</sub>		Source Diode Forward Vo		$V_{GS} = 0 V, I_{SD} = 6.2 A$		-	-	1.4	V
V <sub>SD</sub>		Recovery Time	U				130		
t <sub>rr</sub> Q <sub>rr</sub>		Recovery Charge		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6.2 A, dI <sub>F</sub> /dt = 100 A/μs	-	-	0.6	-	ns
	i coreise i	Coovery charge	,	αιμαι - 100 Λιμο		-	0.0	-	μC



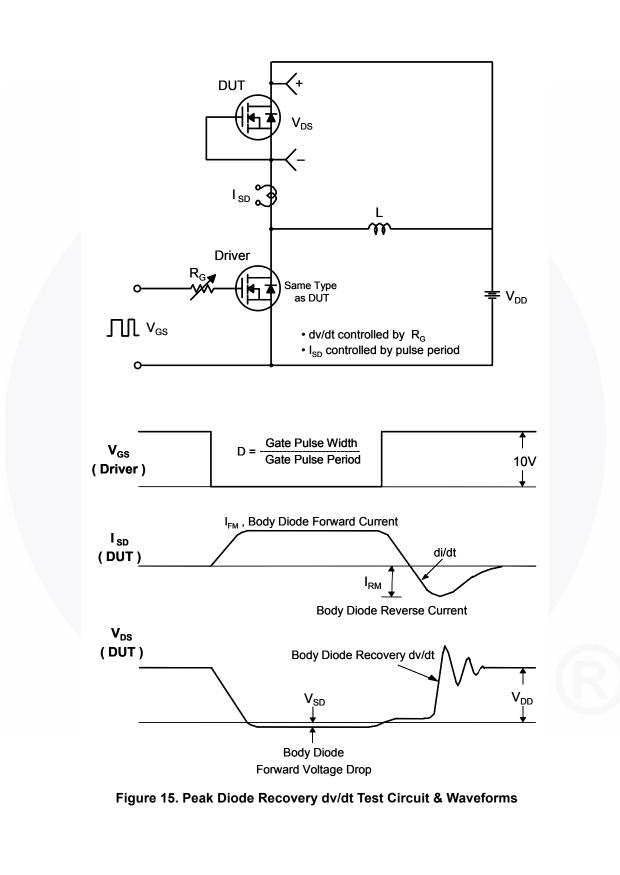
©2010 Fairchild Semiconductor Corporation FDD7N25LZ Rev. 1.5

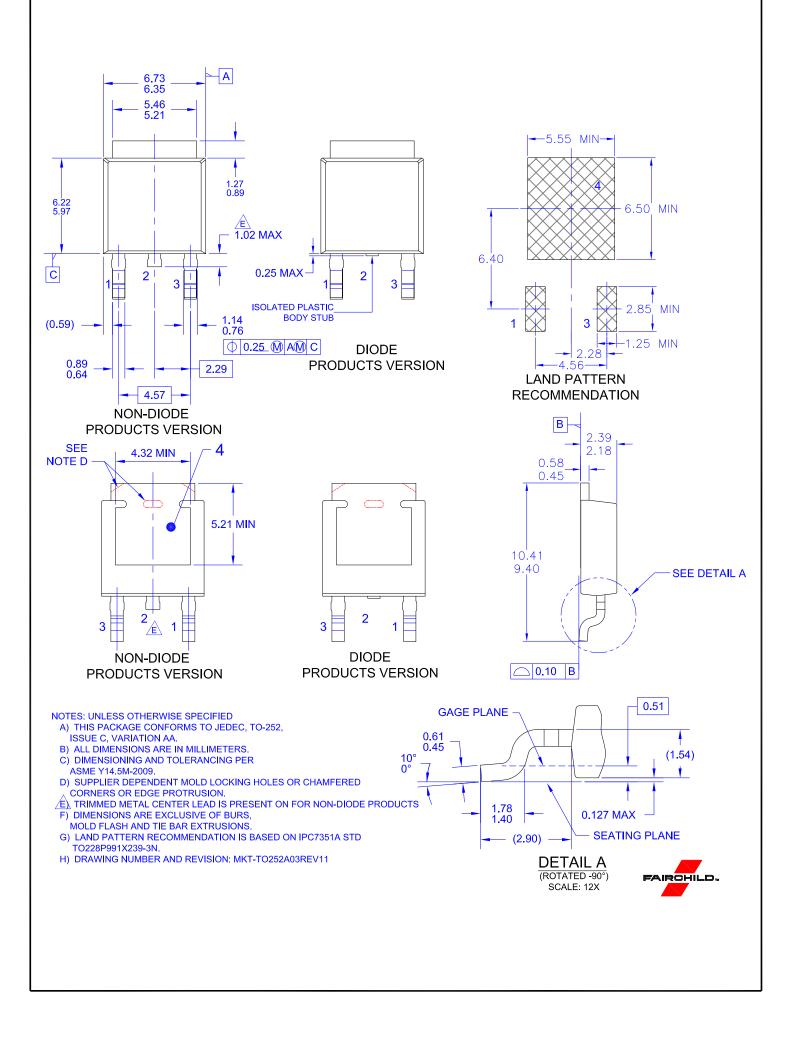




FDD7N25LZ — N-Channel UniFET<sup>TM</sup> MOSFET

FDD7N25LZ — N-Channel UniFET<sup>TM</sup> MOSFET





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60\_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B